

Provisional Data

Rectifier Diode

Types W6908F#450 to W6908F#500

Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V _{RRM}	Repetitive peak reverse voltage, (note 1)	4500-5000	V
V _{RSM}	Non-repetitive peak reverse voltage, (note 1)	4600-5100	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
I _{F(AV)M}	Maximum average forward current, T _{sink} =55°C, (note 2)	6908	A
I _{F(AV)M}	Maximum average forward current. T _{sink} =100°C, (note 2)	4903	A
I _{F(AV)M}	Maximum average forward current. T _{sink} =100°C, (note 3)	3122	A
I _{F(RMS)}	Nominal RMS forward current, T _{sink} =25°C, (note 2)	12596	A
I _{F(d.c.)}	D.C. forward current, T _{sink} =25°C, (note 4)	11424	A
I _{FSM}	Peak non-repetitive surge t _p =10ms, V _{rm} =60%V _{RRM} , (note 5)	70.0	kA
I _{FSM2}	Peak non-repetitive surge t _p =10ms, V _{rm} ≤10V, (note 5)	77.0	kA
I ² t	I ² t capacity for fusing t _p =10ms, V _{rm} =60%V _{RRM} , (note 5)	24.50×10 ⁶	A ² s
I ² t	I ² t capacity for fusing t _p =10ms, V _{rm} ≤10V, (note 5)	29.65×10 ⁶	A ² s
T _{j op}	Operating temperature range	-40 to +160	°C
T _{stg}	Storage temperature range	-55 to +160	°C

Notes:-

- 1) De-rating factor of 0.13% per °C is applicable for T_j below 25°C.
- 2) Double side cooled, single phase; 50Hz, 180° half-sinewave.
- 3) Cathode side cooled, single phase; 50Hz, 180° half-sinewave.
- 4) Double side cooled.
- 5) Half-sinewave, 160°C T_j initial.

Characteristics

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS
V _{FM}	Maximum peak forward voltage	-	-	1.15	I _{FM} =4000A	V
V _{FM}	Maximum peak forward voltage	-	-	1.48	I _{FM} =8000A	V
V _{T0}	Threshold voltage	-	-	0.767		V
r _T	Slope resistance	-	-	0.092		mΩ
I _{R_{RRM}}	Peak reverse current	-	-	20 200	Rated V _{RRM} , T _j =25°C Rated V _{RRM}	mA
Q _{rr}	Recovered charge	-	20000	22000		μC
Q _{ra}	Recovered charge, 50% Chord	-	13500	-	I _{TM} =1000A, t _p =2000μs, di/dt=10A/μs, V _r =100V	μC
I _{rm}	Reverse recovery current	-	390	-		A
t _{rr}	Reverse recovery time, 50% chord	-	70	-		μs
R _{thJK}	Thermal resistance, junction to heatsink	-	-	0.0065 0.0130	Double side cooled Single side cooled	K/W K/W
F	Mounting force	81	-	99	Note 2	kN
W _t	Weight	-	2.0 2.8	-	Outline option FD Outline options FC	kg

Notes:-

- 1) Unless otherwise indicated T_j=160°C.
- 2) For other clamp forces, please consult factory.

Notes on Ratings and Characteristics

1.0 Voltage Grade Table

Voltage Grade	V_{RRM} V	V_{RSM} V	V_R DC V
45	4500	4600	2100
46	4600	4700	2120
48	4800	4900	2160
50	5000	5100	2200

2.0 Extension of Voltage Grades

This report is applicable to other voltage grades when supply has been agreed by Sales/Production.

3.0 De-rating Factor

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for T_j below 25°C.

4.0 Snubber Components

When selecting snubber components, care must be taken not to use excessively large values of snubber capacitor or excessively small values of snubber resistor. Such excessive component values may lead to device damage due to the large resultant values of snubber discharge current. If required, please consult the factory for assistance.

5.0 Computer Modelling Parameters

5.1 Device Dissipation Calculations

$$I_{AV} = \frac{-V_{T0} + \sqrt{V_{T0}^2 + 4 \cdot ff^2 \cdot r_T \cdot W_{AV}}}{2 \cdot ff^2 \cdot r_T} \quad \text{and:} \quad W_{AV} = \frac{\Delta T}{R_{th}}$$

$$\Delta T = T_{j\max} - T_K$$

Where $V_{T0}=0.767V$, $r_T=0.092m\Omega$

R_{th} = Supplementary thermal impedance, see table below and

ff = Form factor, see table below.

Supplementary Thermal Impedance				
Conduction Angle	6 phase (60°)	3 phase (120°)	½ wave (180°)	d.c.
Square wave Double Side Cooled	0.00707	0.00689	0.00673	0.0065
Square wave Cathode Side Cooled	0.01359	0.01349	0.01323	0.0130
Sine wave Double Side Cooled	0.00697	0.00678	0.00654	
Sine wave Cathode Side Cooled	0.01348	0.01328	0.01303	

Form Factors				
Conduction Angle	6 phase (60°)	3 phase (120°)	½ wave (180°)	d.c.
Square wave	2.449	1.732	1.414	1
Sine wave	2.778	1.879	1.57	

5.2 Calculating V_F using ABCD Coefficients

The on-state characteristic I_F vs. V_F , on page 6 is represented in two ways;

- (i) the well established V_{T0} and r_f tangent used for rating purposes and
- (ii) a set of constants A, B, C, D, forming the coefficients of the representative equation for V_F in terms of I_F given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

The constants, derived by curve fitting software, are given below for both hot and cold characteristics. The resulting values for V_F agree with the true device characteristic over a current range, which is limited to that plotted.

25°C Coefficients		160°C Coefficients	
A	0.7502846	A	0.4591932
B	0.01006258	B	0.02387826
C	2.259358×10^{-5}	C	4.533276×10^{-5}
D	3.907947×10^{-3}	D	4.924113×10^{-3}

5.3 D.C. Thermal Impedance Calculation

$$r_t = \sum_{p=1}^{p=n} r_p \cdot \left(1 - e^{-\frac{t}{\tau_p}} \right)$$

Where $p = 1$ to n , n is the number of terms in the series and:

- t = Duration of heating pulse in seconds.
- r_t = Thermal resistance at time t .
- r_p = Amplitude of p_{th} term.
- τ_p = Time Constant of r_{th} term.

The coefficients for this device are shown in the tables below:

D.C. Double Side Cooled				
Term	1	2	3	4
r_p	3.424745×10^{-3}	1.745273×10^{-3}	8.532017×10^{-4}	3.457329×10^{-4}
τ_p	1.125391	0.1878348	0.02788979	8.430889×10^{-3}

D.C. Single Side Cooled				
Term	1	2	3	4
r_p	8.375269×10^{-3}	2.518437×10^{-3}	1.193758×10^{-3}	7.45432×10^{-4}
τ_p	8.929845	0.4711304	0.08221244	0.01221961

6.0 Reverse recovery ratings

(i) Q_{ra} is based on 50% I_{RM} chord as shown in Fig. 1

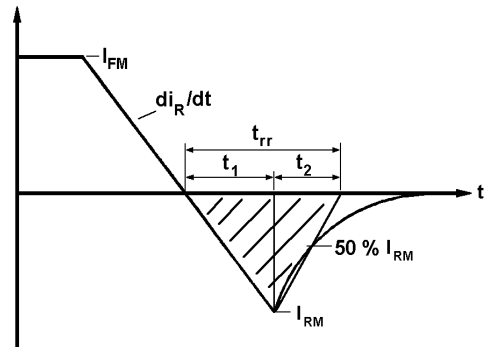


Fig. 1

(ii) Q_{rr} is based on a 150 μ s integration time i.e.

$$Q_{rr} = \int_0^{150\mu s} i_{rr} \cdot dt$$

(iii)

$$K \text{ Factor} = \frac{t_1}{t_2}$$

Curves

Figure 1 – Forward characteristics of Limit device

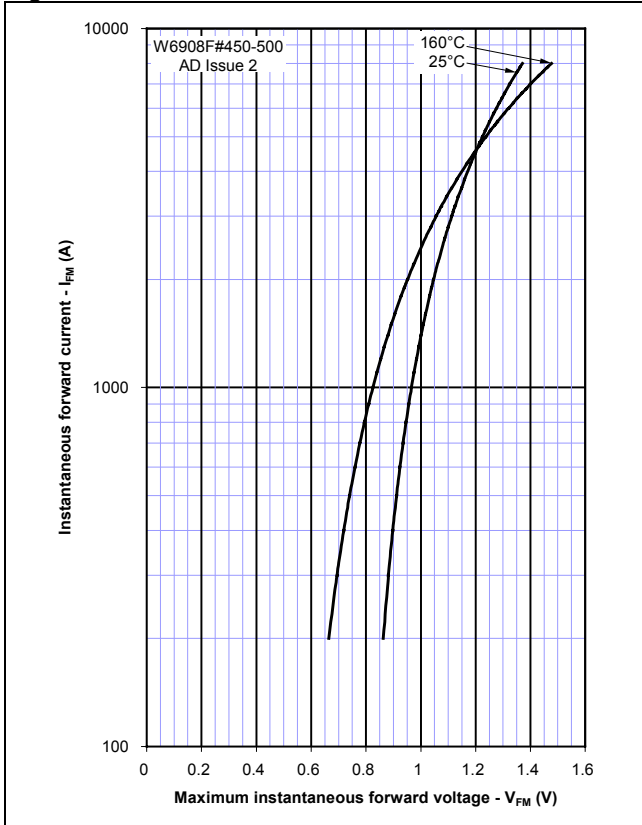


Figure 2 – Transient thermal impedance

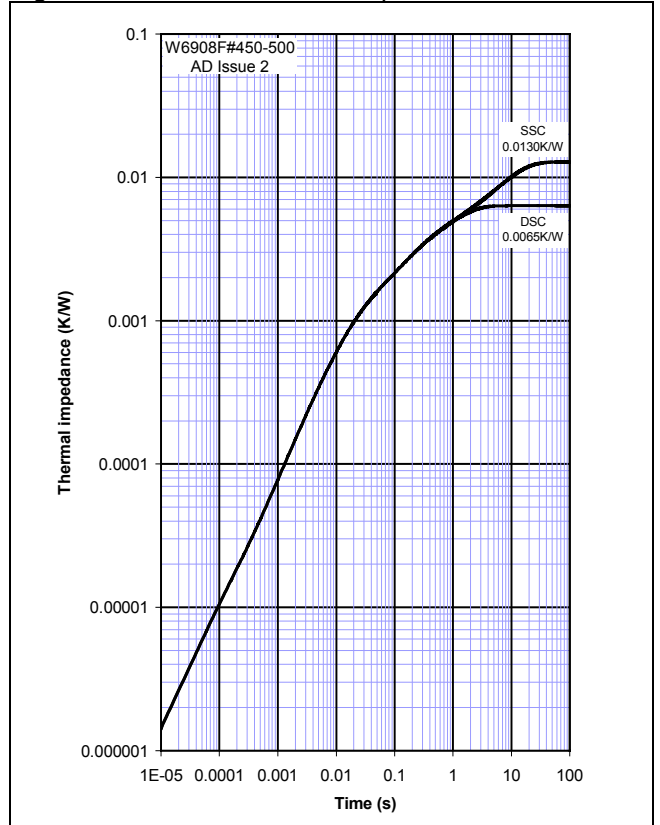


Figure 3 – Maximum Surge Rating

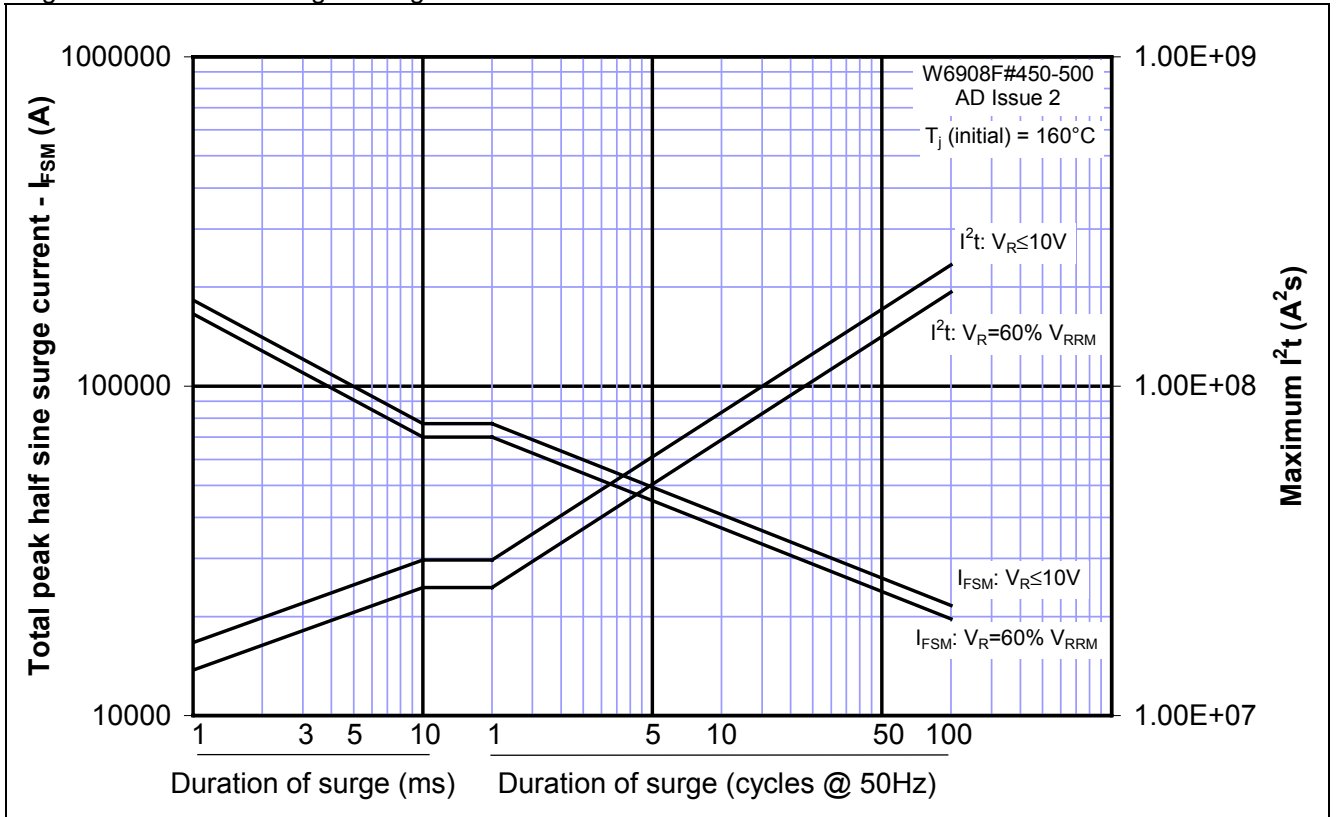


Figure 4 – Total recovered charge, Q_{rr}

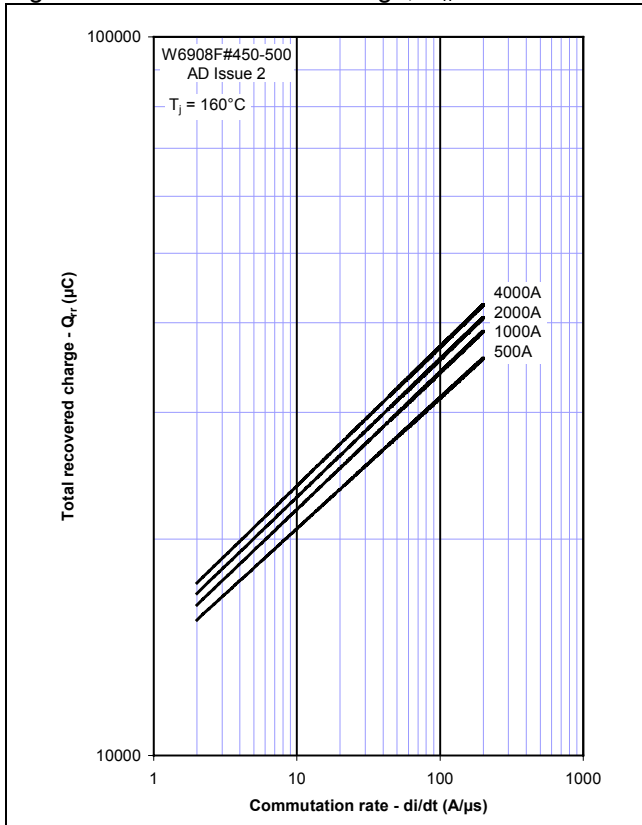


Figure 5 – Recovered charge, Q_{ra} (50% chord)

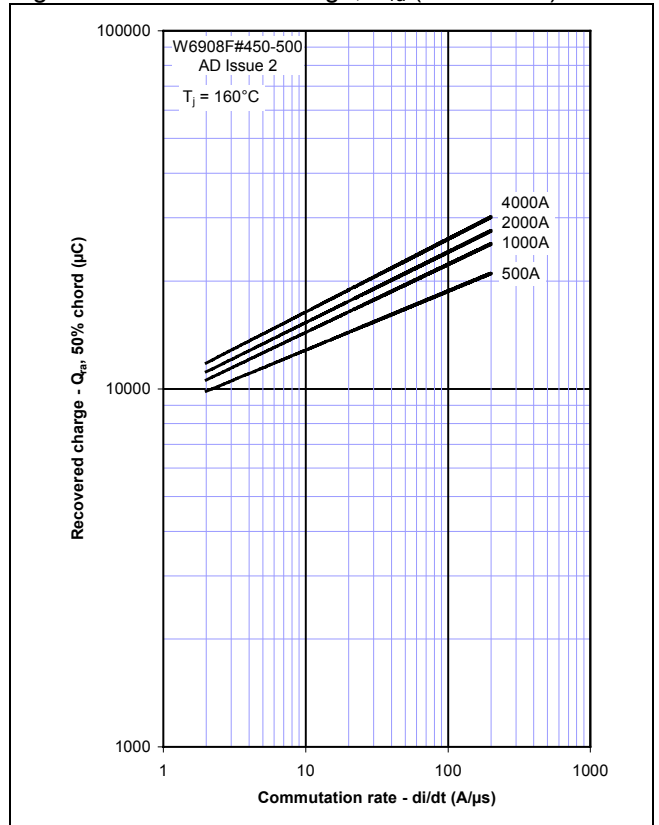


Figure 6 – Peak reverse recovery current, I_{rm}

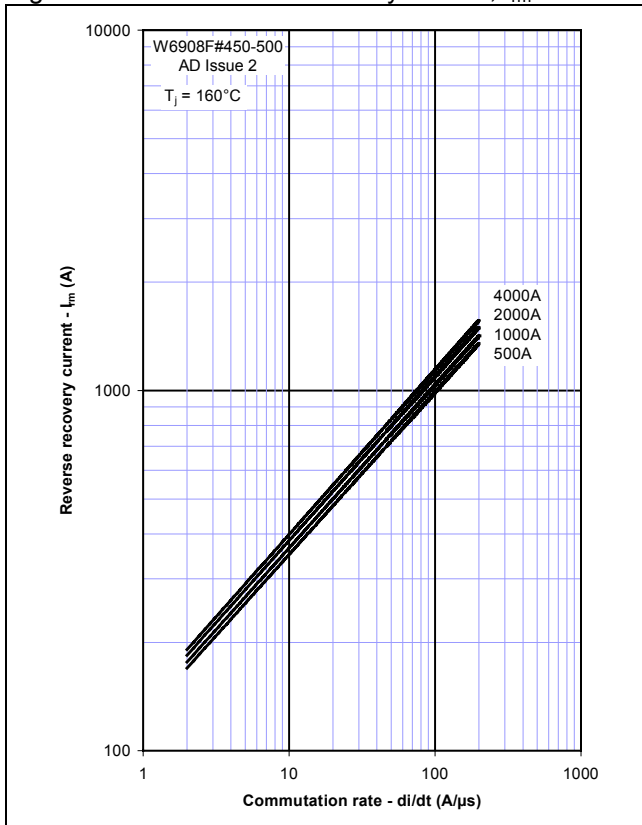


Figure 7 – Maximum recovery time, t_{rr} (50% chord)

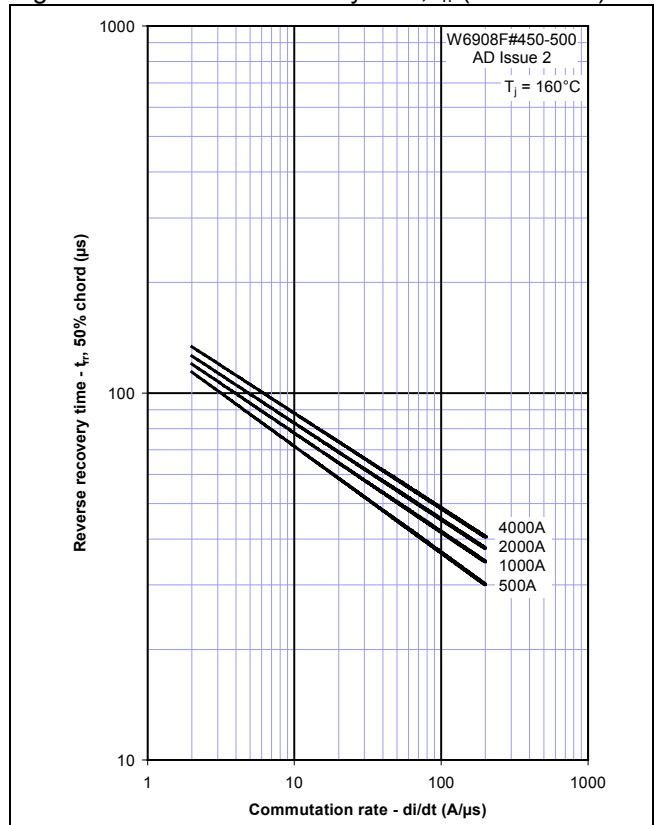


Figure 8 – Forward current vs. Power dissipation – Double Side Cooled

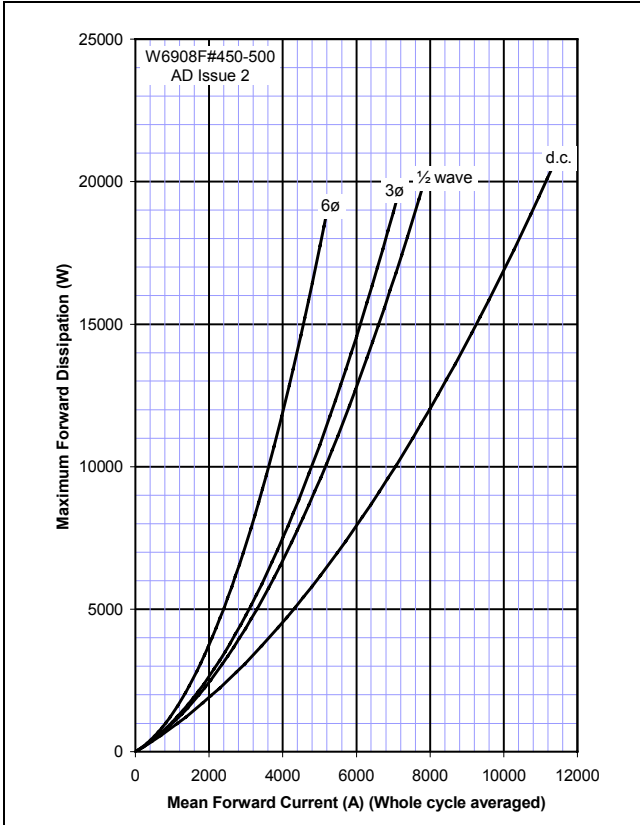


Figure 9 – Forward current vs. Heatsink temperature – Double Side Cooled

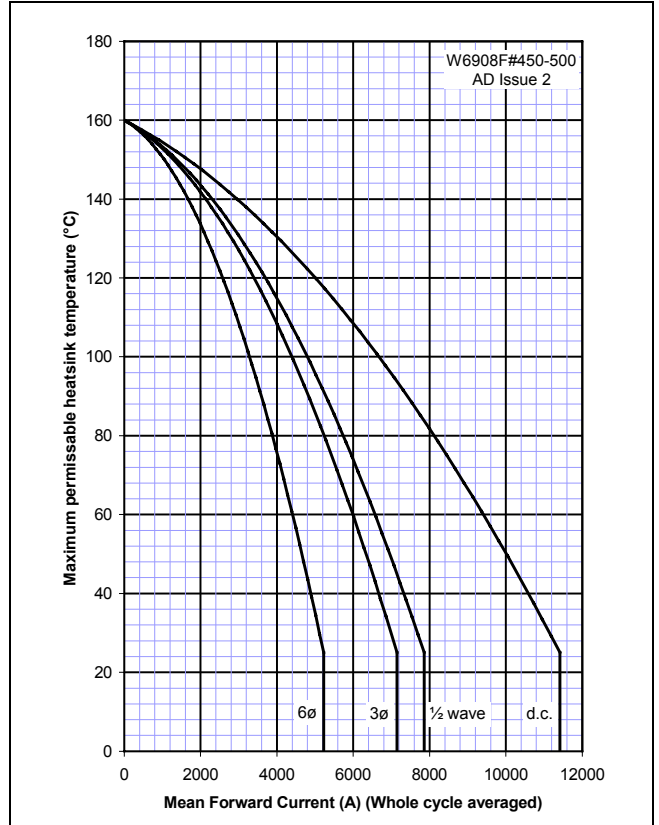


Figure 10 – Forward current vs. Power dissipation – Cathode Side Cooled

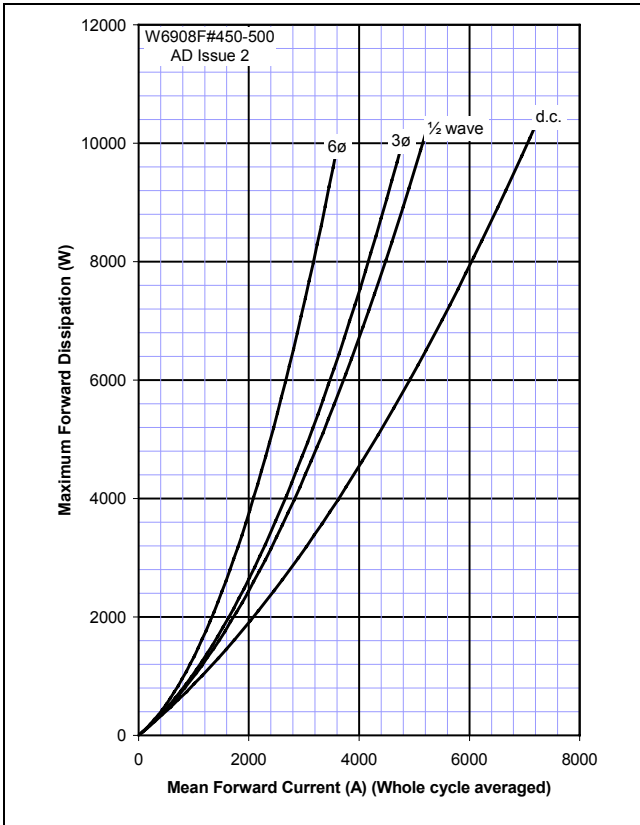
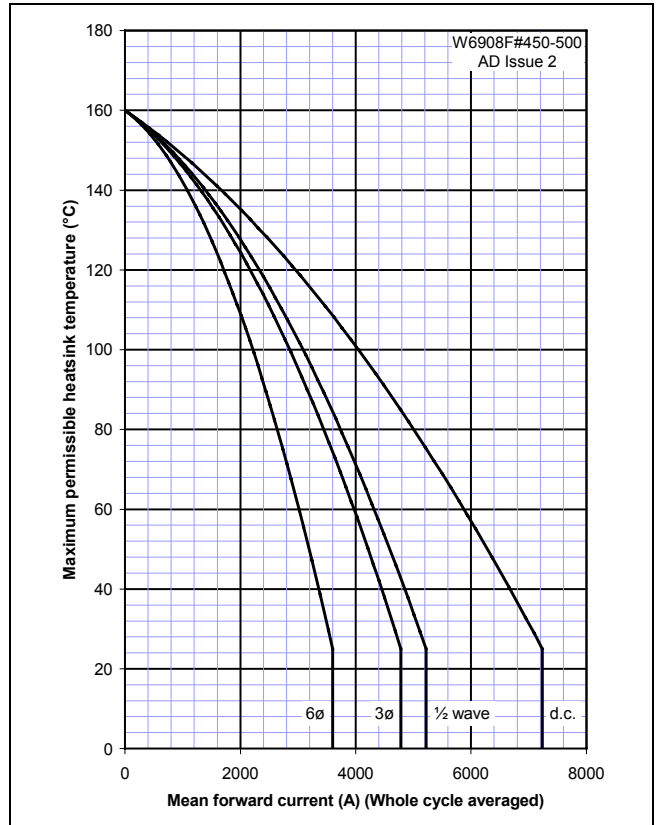
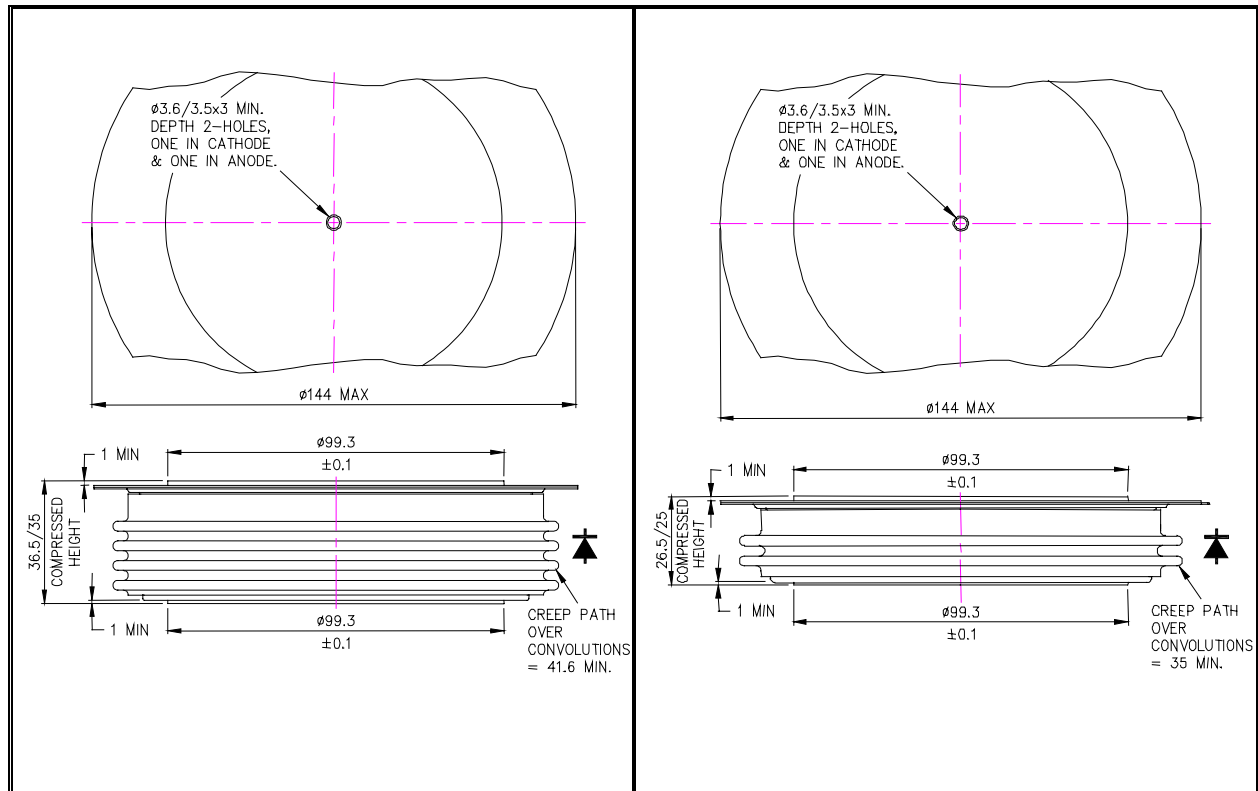


Figure 11 – Forward current vs. Heatsink temperature – Cathode Side Cooled



Outline Drawing & Ordering Information



ORDERING INFORMATION

(Please quote 10 digit code as below)

W6908	F#	◆◆	0
Fixed Type Code	Outline Code FC = Standard 36mm capsule FD = Standard 26mm capsule	Voltage code $V_{RRM}/100$ 45-50	Fixed code

Typical order code: W6908FC500 – 5000V V_{RRM} , 36mm clamp height standard capsule.

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